

**Customer:** 

# **Specification for Approval**

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Customer P/N:	C32827	4									
Product Name:	Power Inductors										
Coilank P/N:	APD04T30M100										
[⊠ New Released, ☐ Revised]											
Approved by	Checked by	Prepared by									
	In an 1 in	Davies Isin									
L	Jean.Lin	Bruce.lan									
<u>Coilank</u>	<u>Technology</u>	Co., Ltd									
ADD: No.39, Chingao Rd.,(305) TEL: 00886-3-5894523 FAX: 00 ADD: Unit D, 16/F Cheuk Nang F TEL: 00852-31135161 FAX: 00 SZ Office TEL: 0755-29452870/3 HTTP: www.coilank.com E-m	886-3-5894415 Plaze 250 Hennessy Road, Wa 9852-31121631 3 FAX : 0755-61658369										
【For Customer approval O	nly] Da	te:									
Qualification Status:	☐ Full ☐ Re	estricted									
Approved By	Verified By	Checked By									
Comments:	Comments:										

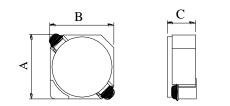


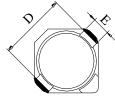
# **Change Note**

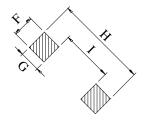
Version	Comtent	Draw	Check	Approval	Date	Coding
1	New Design	Bruce.lan	Jean.lin	Jean.lin	2019.04.18	S153



# 1. External Dimensions (Unit:m/m)







Туре	Α	В	С	D	Е	F	G	H	-	Q'TY/Reel
APD04T30	3.8±0.3	3.8±0.3	2.8±0.3	5.2Max	1.1Ref	1.5Ref	1.4Ref	5.2Ref	2.4Ref	2000

## 2. Part Number Code

<u>APD</u> <u>04</u> <u>T</u> <u>30</u> <u>M</u> <u>100</u> A B C D E F

A: Series Name Power Inductors
B: Dimensions(mm) 04: 3.8x3.8
C: Materials T: T type
D: Thickness(mm) 30: 2.8
E: Tolerance M: ±20%
F: Inductance 100=10uH

### 3. Electrical Characteristics

Part Number	Inductance (uH)	Test Frequency (KHz)	DC Resistance (mΩ)Max.	Saturation Current (A)Max.
APD04T30M100	10.0	100KHz/0.25V	145.0	1.0

### Notes:

- 1) AEC-Q200 qualified.
- 2) All test data is referenced to 25°C ambient.
- 3) Operating temperature range -40°C to +125°C.
- 4) Isat :DC current(A) that will cause lo to drop approximately 35%.
- 5) The part temperature(ambient + temp rise)should not exceed 125°C under worst case operating conditions. circuit design,component placement, PWB trace size and thickness,airflow and other cooling provisions all affect the part temperature,part temperature should be verified in the end application.



### 4. Test Data

E	LECTRICA	L CHARCTE		MECHAN	IICAL DIME	NSIONS		
SPEC	L(uH)	DCR(mΩ)	Isat(uH)	A(mm)	B(mm)	C(mm)	E(mm)	
TOL	10.0	145.0	1.0A	3.8	3.8	2.8	1.1	
NO	±20%	Max	(L0A-L1.0A) /L0A≤35%	±0.3	±0.3	±0.3	Ref	
1	9.18	105.2	7.82	4.05	4.05	2.87	OK	
2	9.44	106.3	7.97	4.02	4.05	2.80	OK	
3	9.33	108.2	7.86	4.03	4.03	2.87	OK	
4	9.42	109.5	8.10	4.03	4.03	2.86	OK	
5	9.37	105.6	8.11	4.04	4.06	2.87	OK	
6	9.26	106.5	8.12	4.06	4.04	2.89	OK	
7	9.38	107.3	8.22	4.02	4.01	2.80	OK	
8	9.43	105.9	8.15	4.06	4.06	2.88	OK	
9	9.29	107.8	8.19	4.02	4.07	2.87	OK	
10	9.26	109.1	8.23	4.04	4.03	2.81	OK	
Test Equip	mets: IM3536,	VR126,VR721	0,Calipers	•	•		•	

### 5. Test and Measurement Procedures

### 5.1 Test Conditions

- 5.1.1 Unless otherwise specified, the standard atmospheric conditions for measurement/test as:
  - a. Ambient Temperature: 20±15℃
  - b. Relative Humidity: 65%±20%
  - c. Air Pressure: 86KPa to 106KPa
- 5.1.2 If any doubt on the results, measurements/tests should be made within the following limits:
  - a. Ambient Temperature: 20±2℃
  - b. Relative Humidity: 65%±5%
  - c. Air Pressure: 86KPa to 106Kpa

### 5.2 Visual Examination

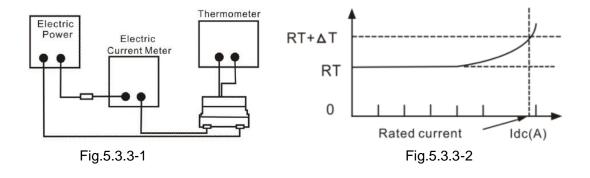
a. Inspection Equipment: 10X magnifier

### 5.3 Electrical Test

- 5.3.1 Inductance (L)
  - a. Refer to the third item.
  - b. Test equipment: IM3536 LCR meter or equivalent.
  - c. Test Frequency and Voltage: Refer to the third item.
- 5.3.2 Direct Current Resistance (DCR)
  - a. Refer to the third item.
  - b. Test equipment: VR126 or equivalent.
- 5.3.3 Current
  - a. Refer to the third item.
  - b. Test equipment (see Fig.5.3.3-1): Electric Power, Electric current meter, Thermometer.
  - c. Measurement method (see Fig. 5.3.3-1):



- 1. Set test current to be 0 mA.
- 2. Measure initial temperature of chip surface.
- 3. Gradually increase voltage and measure chip temperature for corresponding current.
- d. Definition of Temperature rise current: DC current that causes the temperature rise ( $\triangle$  T =40°C) from 20°C ambient (see Fig. 5.3.3-2).



# 5.4 Reliability Test

Item	Specifications	Test conditions
5.4.1 High temperature storage test	No visible mechanical damage. Inductance change: Within ±10%.	Temperature: 125±2°C. Duration:1000hrs. Measured at room temperature after placing for 24±4 hrs.  Temp 125°C High temperature 25°C 0°C 1000H Test Time
5.4.2 Temperature cycling test	No visible mechanical damage. Inductance change: Within ±10%.	Condition for 1 cycle.  Step1: -40±2°C 30min Min.  Step2: 125±2°C, transition time 1min Max.  Step3: 125±2°C 30min Min.  Step4: Low temp, transition time 1min Max.  Number of cycles: 1000.  Measured at room temperature after placing for 24±4 hrs.  Temp  125°C  Change time<1Min  Time
5.4.3 Biased humidity test	No visible mechanical damage. Inductance change: Within ±10%.	Humidity:85% ±3 RH. Temperature:85°C±2°C. Duration:1000hrs. Measured at room temperature after placing for24±4 hrs.



Item	Specifications	Test conditions
5.4.4 Operational life test	No visible mechanical damage. Inductance change: Within ±10%.	Temperature:105±2°C.  Duration :1000hrs.  Measured at room temperature after placing for24±4 hrs.
5.4.5 Resistance to solvent test	No visible mechanical damage. Inductance change: Within ±10%.	Add aqueous wash chemical - OKEM clean or equivalent.
5.4.6 Vibration test	No visible mechanical damage. Inductance change: Within ±10%.	Oscillation Frequency: 10~2K~10Hz for 20 minute.  Total Amplitude:1.52mm±10%.  Testing Time: 12 hours(20 minutes, 12 cycles each of 3 orientations).
5.4.7 Resistance to soldering heat test	No visible mechanical damage. Inductance change: Within ±10%.	Temperature (°C): 260 ±5 (solder temp).  Time (s): 10 ±1.  ramp/immersion and emersion rate: 25mm/s ±6 mm/s.  Number of heat cycles:1.
5.4.8 Solderability test	More than 95% of the terminal electrode should be covered with solder.	Steam Aging: 8 hours ± 15 min. Preheat: 150°C,60sec. Solder: Sn99.5%-Cu0. 5%. Temperature: 245±5°C. Flux for lead free: Rosin. 9.5%. Dip time: 4±1sec. Depth: completely cover the termination.
5.4.9 Terminal strength (SMD) test	No visible mechanical damage.	With the component mounted on a PCB with the device to be tested, apply a 17.7 N (1.8 Kg) force to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied radually as not to apply a shock to the component being tested.

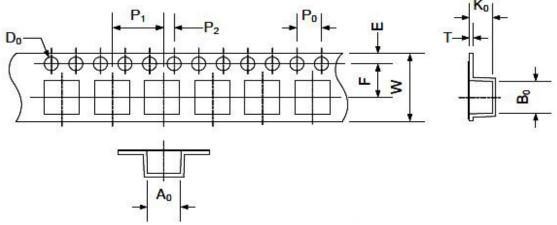


# 6. Packaging, Storage

# 6.1 Tape and Reel Packaging Dimensions

### 6.1 .1 Taping Dimensions (Unit: mm)

Please refer to Fig. 6.1.1-1



6.1.1-1

TYPE	A0	В0	W	Е	F	P0	P1	P2	Т	K0
APD04T30	4.5±0.1	4.5±0.1	12.0±0.3	1.75±0.1	5.5±0.1	4.0±0.1	8.0±0.1	2.0±0.1	0.4±0.1	3.4±0.1

## 6.1.2 Reel Dimensions (Unit: mm)

Please refer to Fig. 6.1.2-1.

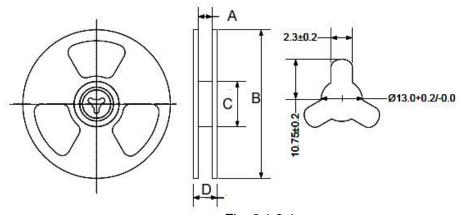


Fig. 6.1.2-1.

TYPE	Α	В	С	D
APD04T30	12.5±2.0	330.0±2.0	100.0±2.0	16.5±2.0



## 6.2 Packaging

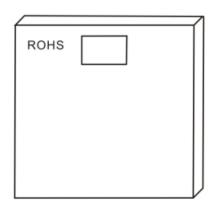
6.2.1 The inner box specification: 350\*340\*40MM

Packing quantity: 4000PCS/box

Bubble bag: 37\*45CM

Job description: putting the air bubble bag products placed

inside the box, sealed with scotch tape



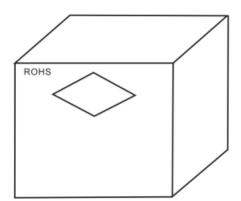
6.2.2 the outside box specification: 370\*360\*255MM

Packing quantity: 20000PCS/ box

Job description: will be outside the box bottom

sealed, inner box into the box.

- a. with transparent tape sealed box at the top
- b. the specified location with a box labels in the outer box.
- c.if the mantissa box under a FCL with inner box or filling full



# 6.3 Storage

- a.To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.
- b. Recommended conditions: -10°C~40°C, 70%RH (Max.)
- c.The ambient temperature must be kept below 30 °C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, product should be used with one year from the time of delivery.
- d. In case of storage over 6 months, solderability shall be checked before actual usage.



# 7. Recommended Soldering Technologies

### 7.1 Re-flowing Profile:

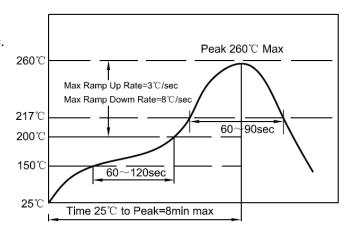
△ Preheat condition: 150~200°C/60~120sec.

△ Allowed time above 217°C: 60~90sec.

△ Max time at max temp: 5sec.

△ Solder paste: Sn/3.0Ag/0.5Cu

△ Allowed Reflow time: 2x max



### 7.2 Iron Soldering Profile:

△ Iron soldering power: Max.30W

Δ Pre-heating: 150°C/60sec.

∆ Soldering Tip temperature: 350 °C Max.

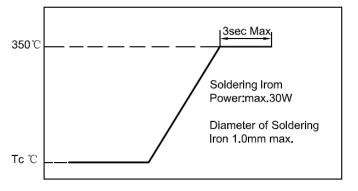
△ Soldering time: 3sec Max.

△ Solder paste: Sn/3.0Ag/0.5Cu

△ Max.1 times for iron soldering

[Note: Take care not to apply the tip of the

soldering iron to the]



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